RUDU

GENERAL DESCRIPTION:-

The 8050 is an NPN epitaxial silicon planar transistor designed for use in the audio output stage and converter/inverter circuits. Complementary to 8550.

ABSOLUTE MAXIMUM RATINGS (Note 1)

Maximum Temperatures
Storage Temperature -55°C to +135°C
Operating Temperature 135°C
Lead Temperature (soldering, 10 seconds time limit) 230°C
Maximum power Dissipation
Total Dissipation at 25°C Ambient Temperature (Note 2) 1.0 Watt Total Dissipation at 25°C Case Temperature (Note 2) 3.0 Watt Maximum Voltage

VCBO Collector to Base Voltage

VCBO Collector to Base Voltage 30V
VCEO Collector to Emitter Voltage (Note 3) 25V
VEBO Emitter to Base Voltage 6V
IC Collector current (continuous) 1.5A

TO-92A



EBC

ELECTRICAL CHARACTERISTICS (25°C Free Air Temperature unless otherwise noted)

SYMBOL	CHARACTERISTICS	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS	
HFE1	DC current gain (Note 4)	85		300		Ic = 100mA Vce = 1V	
HFE2	DC current gain	40		<u> </u>		Ic = 800mA Vce = 1V	
VCE (SAT)	Collector Saturation Voltage (Note 4)		0.2	0,5	V	Ic = 800mA Ib = 80mA	
VBE (SAT)	Base Saturation Voltage (Note 4)		0,92	1,2	V	Ic = 800mA Ib = 80mA	
LVceo	Collector to Emitter breakdown Voltage (Note 3 & 4)	25			V	lc = 10mA lb = 0	
BVcbo	Collector to Base breakdown voltage	30			V	lc = 100uA le = 0	
BVebo	Emitter to Base breakdown voltage	6			V	le = 100uA lc = 0	
Icbo	Collector cutoff current			0.1	uA	Vcb= 20V le = 0	
hfe	High frequency current gain	1.0				Ic = 50mA Vce = 10V	
						f = 100MHz	
Ccb	Collector to Base capacitance			40	pF	Vcb= 10V lc = 0	
	•					f = 1MHz	

NOTES:

- (1) These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.
- (2) These ratings give a maximum junction temperature of 145°C, junction to ambient thermal resistance of 120°C/Watt (derating factor of 8.33mW/°C) and junction to case thermal resistence of 40°C/W (derating factor of 25mW/°C)
- (3) Rating refers to a high-current point where collector-to-emitter voltage is lowest.
- (4) Pulse Conditions: length≤300 us; duty cycle ≤ 2%

CLASSIFICATION OF HFE GROUP

GROUP	MIN	MAX	TEST CONDITION
В	85	160	Ic = 100mA
С	120	200	Ic = 100mA
D	160	300	Ic = 100mA



MICRO ELECTRONICS LTD. 美科有限公司

38 Hung To Road, Kwun Tong, Kowloon, Hong Kong. Cable: Microtron, Hong Kong. Telex: 43510 Micro HX. P.O. Box 9477, Kwun Tong. Tel: 3-430181-6 FAX: 3-410321

This datasheet has been download from:

www.datasheetcatalog.com

Datasheets for electronics components.